



TST, HTST, ZST SERIES

Note: For added mechanical stability, Samtec

recommends mechanical board spacers be

used in applications with gold or selective

ipg@samtec.com for more information.

gold plated connectors. Contact

(2.54 mm) .100"

SHROUDED .025" SQ POST IDC HEADERS

Mates with:

SPECIFICATIONS

For complete specifications www.samtec.com?TST www.samtec.com?HTST or www.samtec.com?ZST

Insulator Material: TST, ZST: Black Glass Filled Polyester HTST: Natural LCP Insulation Resistance: 5000 M Ω min Terminal Material:

Phosphor Bronze Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating (IDSD/TST):

3.4 A per pin (1 pin powered per row) Operating Temp Range: -55 °C to +125 °C with Gold -55 °C to +105 °C with Tin Flammability Rating: UL 94V-O Withstanding Voltage:

1000 VRMS RoHS Compliant: Yes

Processing: Lead-Free Solderable: HTST: Yes TST, ZST: Wave Only SMT Lead Coplanarity: (0.10 mm) .004" max (05-15) (0.15 mm) .006" max (17-36)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



OTHER SOLUTIONS

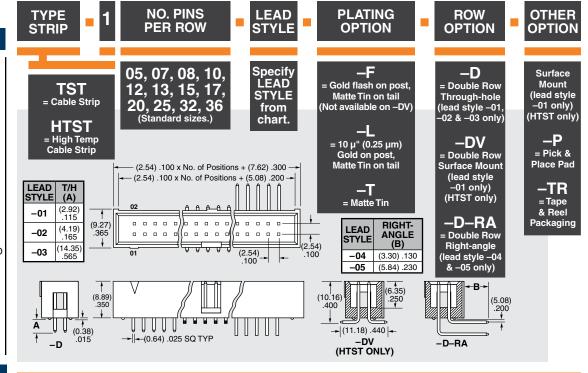
· Shrouded board-to-board headers and stackers to mate with SSW, SSQ, ESW, ESQ, SSM and BCS Series. See TSS, HTSS and ZSS Series.

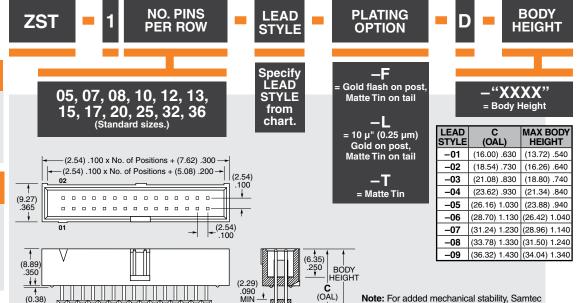
ALSO AVAILABLE (MOQ Required)

- · Other platings & sizes
- · Alignment Pins
- Single Row
- · Locking Leads
- Polarized

Contact Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable. ZST is non-standard, non-returnable.





-(0.64) .025 SQ TYP

*

(2.54)